

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6700438

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KAI CHENG	05/07/2021
PENG XIANG	05/07/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ENKRIS SEMICONDUCTOR, INC.
<b>Street Address:</b>	ROOM 517-A, BUILDING NW-20, NO. 99, JINJI LAKE AVENUE, SUZHOU INDUSTRIAL PARK
<b>City:</b>	SUZHOU
<b>State/Country:</b>	CHINA
<b>Name:</b>	YU ZHU
<b>Street Address:</b>	ROOM 604, BUILDING 35, SUJIAN RESIDENTIAL QUARTERS, RENMIN EAST ROAD, CHONGCHUAN DISTRICT
<b>City:</b>	NANTONG
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17315665
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
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<b>Phone:</b>	425-659-3366
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<b>ATTORNEY DOCKET NUMBER:</b>	P-21BR1043US
<b>NAME OF SUBMITTER:</b>	ZHENGYUN LUO
<b>SIGNATURE:</b>	/Zhengyun Luo/
<b>DATE SIGNED:</b>	05/10/2021
<b>Total Attachments: 2</b>	

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# Combined Declaration and Assignment for Utility or Design Patent Application

## DECLARATION

Title of Invention	SEMICONDUCTOR STRUCTURE AND PREPARATION METHOD THEREOF
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As the below named inventor, I hereby declare that:

This declaration is directed to: ☒ The attached application, or

☐ United States application \_\_\_\_\_

filed on \_\_\_\_\_.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

## ASSIGNMENT

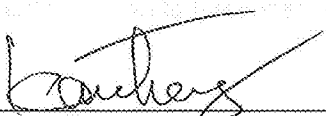
For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged by the undersigned inventor(s) (hereinafter ASSIGNOR). The undersigned ASSIGNOR hereby:

1. Sell, assign and transfer to ENKRIS SEMICONDUCTOR, INC., a corporation in the People's Republic of China having a place of residence at Room 517-A, Building NW-20, No. 99, Jinji Lake Avenue, Suzhou Industrial Park, Suzhou, Jiangsu 215123, China and Yu ZHU, an individual in the People's Republic of China having a place of residence at Room 604, Building 35, Sujian Residential Quarters, Renmin East Road, Chongchuan District, Nantong, Jiangsu 226007, China (hereinafter ASSIGNEE), the entire right, title and interest in any and all improvements and inventions disclosed in applications based upon, and patents (including foreign patents and the right to claim priority) granted upon, the above-referenced application.
2. Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division, continuation, substitute, renewal, re-examination or reissue thereof to the ASSIGNEE.

3. Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
4. Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the inventor, as well as the inventor's heirs, legal representatives and assigns.
5. Warrant and represent that we have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.
6. Authorize and request our representatives to insert the application number and any other identification which may be necessary or desirable for purposes of recordation of this assignment.

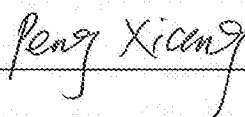
Hereby executed by the undersigned on the date opposite the undersigned name:

Legal name of inventor: Kai CHENG

Inventor's signature: 

Date: 2021.05.07

Legal name of inventor: Peng XIANG

Inventor's signature: 

Date: 2021.05.07